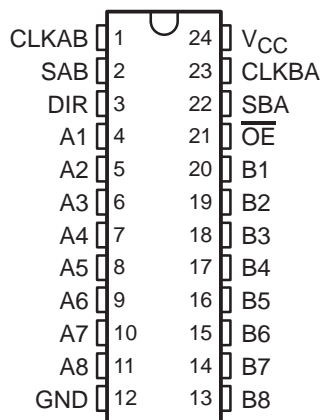


# SN54LVTH646, SN74LVTH646 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

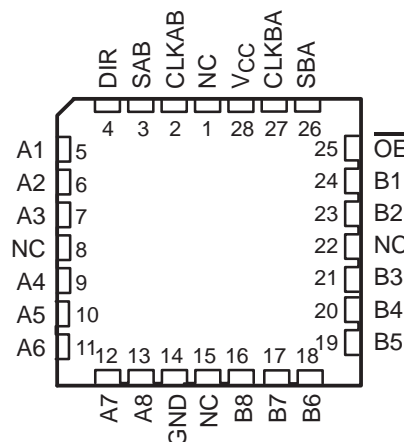
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- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V  $V_{CC}$ )
- Support Unregulated Battery Operation Down to 2.7 V
- Typical  $V_{OLP}$  (Output Ground Bounce)  $<0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- $I_{off}$  and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

SN54LVTH646 . . . JT OR W PACKAGE  
SN74LVTH646 . . . DB, DGV, DW, NS, OR PW PACKAGE  
(TOP VIEW)



SN54LVTH646 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

## description/ordering information

These bus transceivers and registers are designed specifically for low-voltage (3.3-V)  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment.

## ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SOIC – DW	Tube	SN74LVTH646DW	LVTH646
		Tape and reel	SN74LVTH646DWR	
	SOP – NS	Tape and reel	SN74LVTH646NSR	LVTH646
	SSOP – DB	Tape and reel	SN74LVTH646DBR	LXH646
	TSSOP – PW	Tube	SN74LVTH646PW	LXH646
		Tape and reel	SN74LVTH646PWR	
	TVSOP – DGV	Tape and reel	SN74LVTH646DGV	LXH646
–55°C to 125°C	CDIP – JT	Tube	SNJ54LVTH646JT	SNJ54LVTH646JT
	CFP – W	Tube	SNJ54LVTH646W	SNJ54LVTH646W
	LCSS – FK	Tube	SNJ54LVTH646FK	SNJ54LVTH646FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# SN54LVTH646, SN74LVTH646

## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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### description/ordering information (continued)

The 'LVTH646 devices consist of bus transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'LVTH646.

Output-enable ( $\overline{OE}$ ) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port can be stored in either register or in both.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. The direction control (DIR) determines which bus receives data when  $\overline{OE}$  is low. In the isolation mode ( $\overline{OE}$  high), A data can be stored in one register and/or B data can be stored in the other register.

When an output function is disabled, the input function still is enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

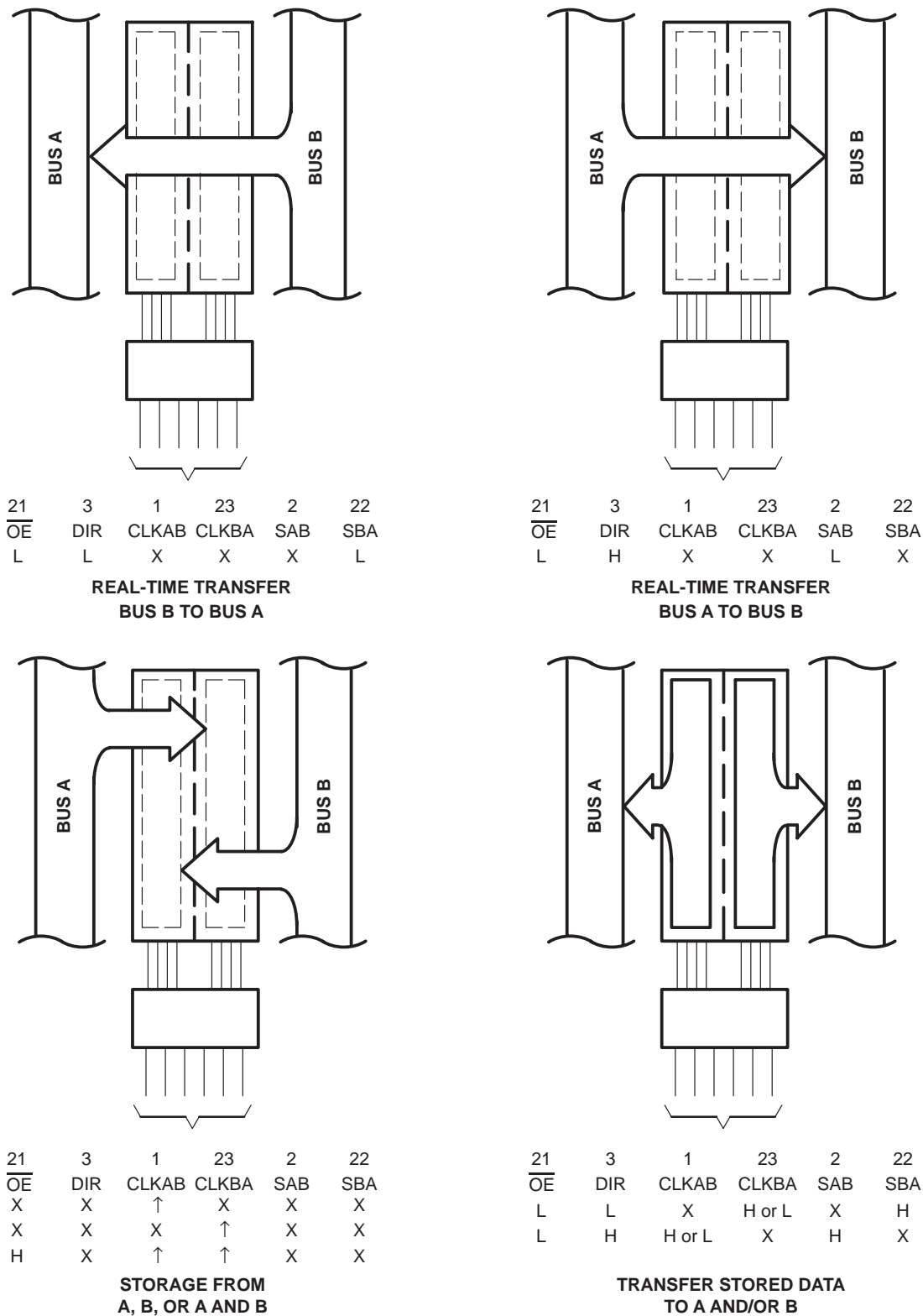
FUNCTION TABLE

INPUTS						DATA I/Os		OPERATION OR FUNCTION
$\overline{OE}$	DIR	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
X	X	↑	X	X	X	Input	Unspecified†	Store A, B unspecified†
X	X	X	↑	X	X	Unspecified†	Input	Store B, A unspecified†
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input disabled	Input disabled	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time A data to B bus
L	H	H or L	X	H	X	Input	Output	Stored A data to B bus

† The data-output functions can be enabled or disabled by various signals at  $\overline{OE}$  and DIR. Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

# SN54LVTH646, SN74LVTH646 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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Pin numbers shown are for the DB, DGV, DW, JT, NS, PW, and W packages.

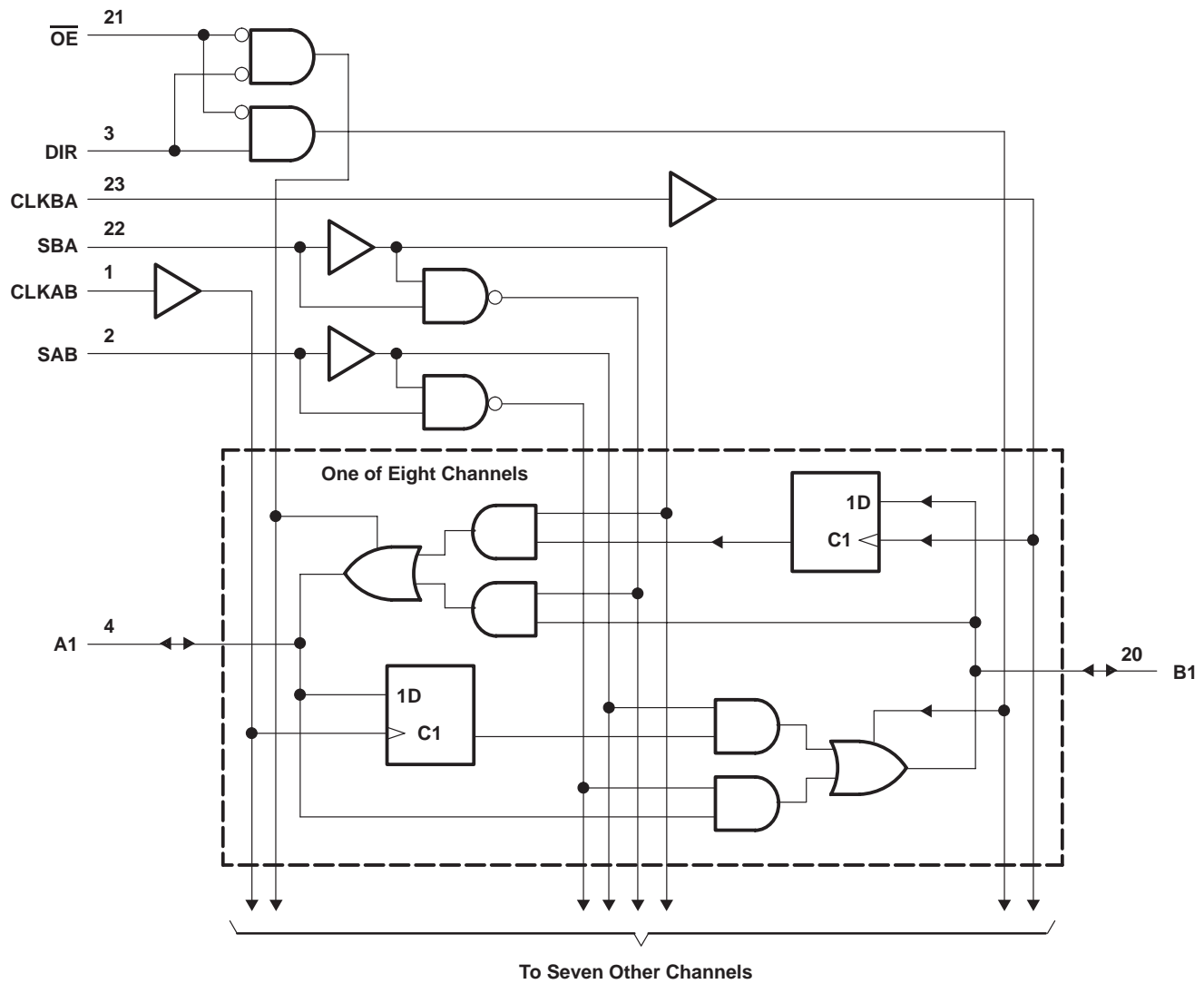
**Figure 1. Bus-Management Functions**

# SN54LVTH646, SN74LVTH646

## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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### logic diagram (positive logic)



Pin numbers shown are for the DB, DGV, DW, JT, NS, PW, and W packages.

# SN54LVTH646, SN74LVTH646 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$ .....	-0.5 V to 4.6 V
Input voltage range, $V_I$ (see Note 1) .....	-0.5 V to 7 V
Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) .....	-0.5 V to 7 V
Voltage range applied to any output in the high state, $V_O$ (see Note 1) .....	-0.5 V to $V_{CC} + 0.5$ V
Current into any output in the low state, $I_O$ : SN54LVTH646 .....	96 mA
SN74LVTH646 .....	128 mA
Current into any output in the high state, $I_O$ (see Note 2): SN54LVTH646 .....	48 mA
SN74LVTH646 .....	64 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....	-50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ ) .....	-50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DB package .....	63°C/W
DGV package .....	86°C/W
DW package .....	46°C/W
NS package .....	65°C/W
PW package .....	88°C/W
Storage temperature range, $T_{stg}$ .....	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
 2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .  
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 4)

	SN54LVTH646		SN74LVTH646		UNIT
	MIN	MAX	MIN	MAX	
$V_{CC}$ Supply voltage	2.7	3.6	2.7	3.6	V
$V_{IH}$ High-level input voltage	2		2		V
$V_{IL}$ Low-level input voltage		0.8		0.8	V
$V_I$ Input voltage		5.5		5.5	V
$I_{OH}$ High-level output current		-24		-32	mA
$I_{OL}$ Low-level output current		48		64	mA
$\Delta t/\Delta v$ Input transition rise or fall rate	Outputs enabled		10	10	ns/V
$\Delta t/\Delta V_{CC}$ Power-up ramp rate	200		200		$\mu$ s/V
$T_A$ Operating free-air temperature	-55	125	-40	85	°C

NOTE 4: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



# SN54LVTH646, SN74LVTH646

## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54LVTH646			SN74LVTH646			UNIT
		MIN	TYP†	MAX	MIN	TYP†	MAX	
$V_{IK}$	$V_{CC} = 2.7\text{ V}$ , $I_I = -18\text{ mA}$			-1.2			-1.2	V
$V_{OH}$	$V_{CC} = 2.7\text{ V to }3.6\text{ V}$ , $I_{OH} = -100\text{ }\mu\text{A}$	$V_{CC}-0.2$			$V_{CC}-0.2$			V
	$V_{CC} = 2.7\text{ V}$ , $I_{OH} = -8\text{ mA}$	2.4			2.4			
	$V_{CC} = 3\text{ V}$	2			2			
$V_{OL}$	$V_{CC} = 2.7\text{ V}$	$I_{OL} = 100\text{ }\mu\text{A}$		0.2		0.2		V
		$I_{OL} = 24\text{ mA}$		0.5		0.5		
	$V_{CC} = 3\text{ V}$	$I_{OL} = 16\text{ mA}$		0.4		0.4		
		$I_{OL} = 32\text{ mA}$		0.5		0.5		
		$I_{OL} = 48\text{ mA}$		0.55		0.55		
$I_I$	Control inputs	$V_{CC} = 3.6\text{ V}$ , $V_I = V_{CC}\text{ or GND}$		$\pm 1$		$\pm 1$		$\mu\text{A}$
		$V_{CC} = 0\text{ or }3.6\text{ V}$ , $V_I = 5.5\text{ V}$		10		10		
	A or B ports‡	$V_{CC} = 3.6\text{ V}$ , $V_I = 5.5\text{ V}$		20		20		
		$V_{CC} = 3.6\text{ V}$ , $V_I = V_{CC}$ $V_I = 0$		1 -5		1 -5		
$I_{off}$	$V_{CC} = 0$ , $V_I\text{ or }V_O = 0\text{ to }4.5\text{ V}$					$\pm 100$		$\mu\text{A}$
$I_{I(\text{hold})}$	A or B ports	$V_{CC} = 3\text{ V}$ , $V_I = 0.8\text{ V}$ $V_I = 2\text{ V}$		75 -75		75 -75		$\mu\text{A}$
		$V_{CC} = 3.6\text{ V}\S$ , $V_I = 0\text{ to }3.6\text{ V}$				$\pm 500$		
$I_{OZPU}$	$V_{CC} = 0\text{ to }1.5\text{ V}$ , $V_O = 0.5\text{ V to }3\text{ V}$ , $OE = \text{don't care}$			$\pm 100$		$\pm 100$		$\mu\text{A}$
$I_{OZPD}$	$V_{CC} = 1.5\text{ V to }0$ , $V_O = 0.5\text{ V to }3\text{ V}$ , $OE = \text{don't care}$			$\pm 100$		$\pm 100$		$\mu\text{A}$
$I_{CC}$	$V_{CC} = 3.6\text{ V}$ , $I_O = 0$ , $V_I = V_{CC}\text{ or GND}$	Outputs high		0.19		0.19		mA
		Outputs low		5		5		
		Outputs disabled		0.19		0.19		
$\Delta I_{CC}\P$	$V_{CC} = 3\text{ V to }3.6\text{ V}$ , One input at $V_{CC} - 0.6\text{ V}$ , Other inputs at $V_{CC}\text{ or GND}$			0.2		0.2		mA
$C_i$	$V_I = 3\text{ V or }0$			4		4		pF
$C_{io}$	$V_O = 3\text{ V or }0$			9		9		pF

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ Unused terminals at  $V_{CC}$  or GND

§ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level, rather than  $V_{CC}$  or GND.



# SN54LVTH646, SN74LVTH646

## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

		SN54LVTH646				SN74LVTH646				UNIT		
		V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V				
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX			
f <sub>clock</sub>	Clock frequency	150		150		150		150		MHz		
t <sub>w</sub>	Pulse duration, CLK high or low	3.3		3.3		3.3		3.3		ns		
t <sub>su</sub>	Setup time, A or B before CLKAB↑ or CLKBA↑	Data high		1.3		1.6		1.2		1.5		ns
		Data low		1.9		2.6		1.6		2.2		
t <sub>h</sub>	Hold time, A or B after CLKAB↑ or CLKBA↑	1.2		1.2		0.8		0.8		ns		

switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LVTH646				SN74LVTH646				UNIT	
			V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V			V <sub>CC</sub> = 2.7 V		
			MIN	MAX	MIN	MAX	MIN	TYP†	MAX	MIN		MAX
f <sub>max</sub>			150		150		150			150		MHz
t <sub>PLH</sub>	CLKBA or CLKAB	A or B	1	5.3	5.9		1.8	3.1	4.7	5.6		ns
t <sub>PHL</sub>			1.5	5	5.9		1.8	3.1	4.7	5.6		
t <sub>PLH</sub>	A or B	B or A	1	4.9	5.6		1.3	2.3	3.5	4.1		ns
t <sub>PHL</sub>			1.2	4.8	5		1.3	2.4	3.5	4.1		
t <sub>PLH</sub>	SBA or SAB‡	A or B	1	5.3	6.3		1.5	3	4.9	6		ns
t <sub>PHL</sub>			1.3	5.3	6.3		1.5	3.3	4.9	6		
t <sub>PZH</sub>	$\overline{\text{OE}}$	A or B	1	5.4	6.7		1.1	3.1	5.2	6.5		ns
t <sub>PZL</sub>			1	5.6	6.7		1.1	3.4	5.2	6.5		
t <sub>PHZ</sub>	$\overline{\text{OE}}$	A or B	1.7	6.3	6.5		2.3	3.9	5.5	6.1		ns
t <sub>PLZ</sub>			2.2	6.3	6.5		2.3	4	5.5	5.9		
t <sub>PZH</sub>	DIR	A or B	1.2	5.6	6.8		1.3	3.4	5.2	6.6		ns
t <sub>PZL</sub>			1.2	6.7	6.8		1.3	3.6	5.2	6.6		
t <sub>PHZ</sub>	DIR	A or B	1.1	7.2	8.1		1.5	3.2	5.6	6.7		ns
t <sub>PLZ</sub>			1.4	6.1	6.6		1.5	3.8	5.6	6.3		

† All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

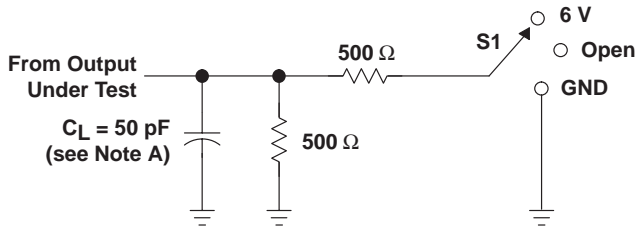
‡ These parameters are measured with the internal output state of the storage register opposite that of the bus input.

# SN54LVTH646, SN74LVTH646

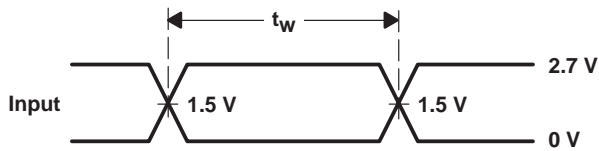
## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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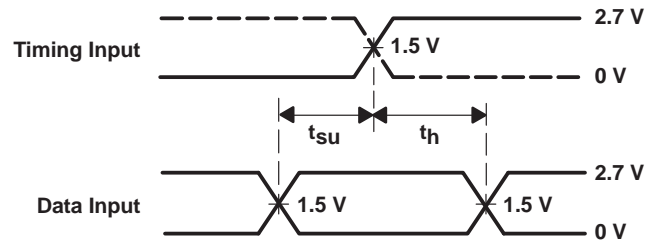
### PARAMETER MEASUREMENT INFORMATION



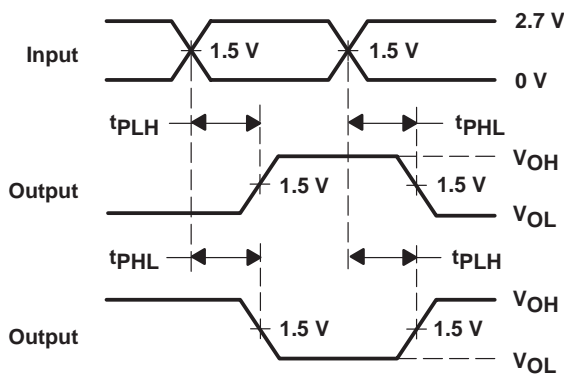
LOAD CIRCUIT



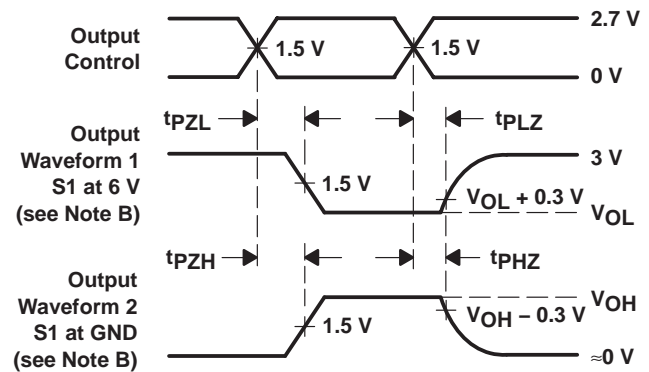
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

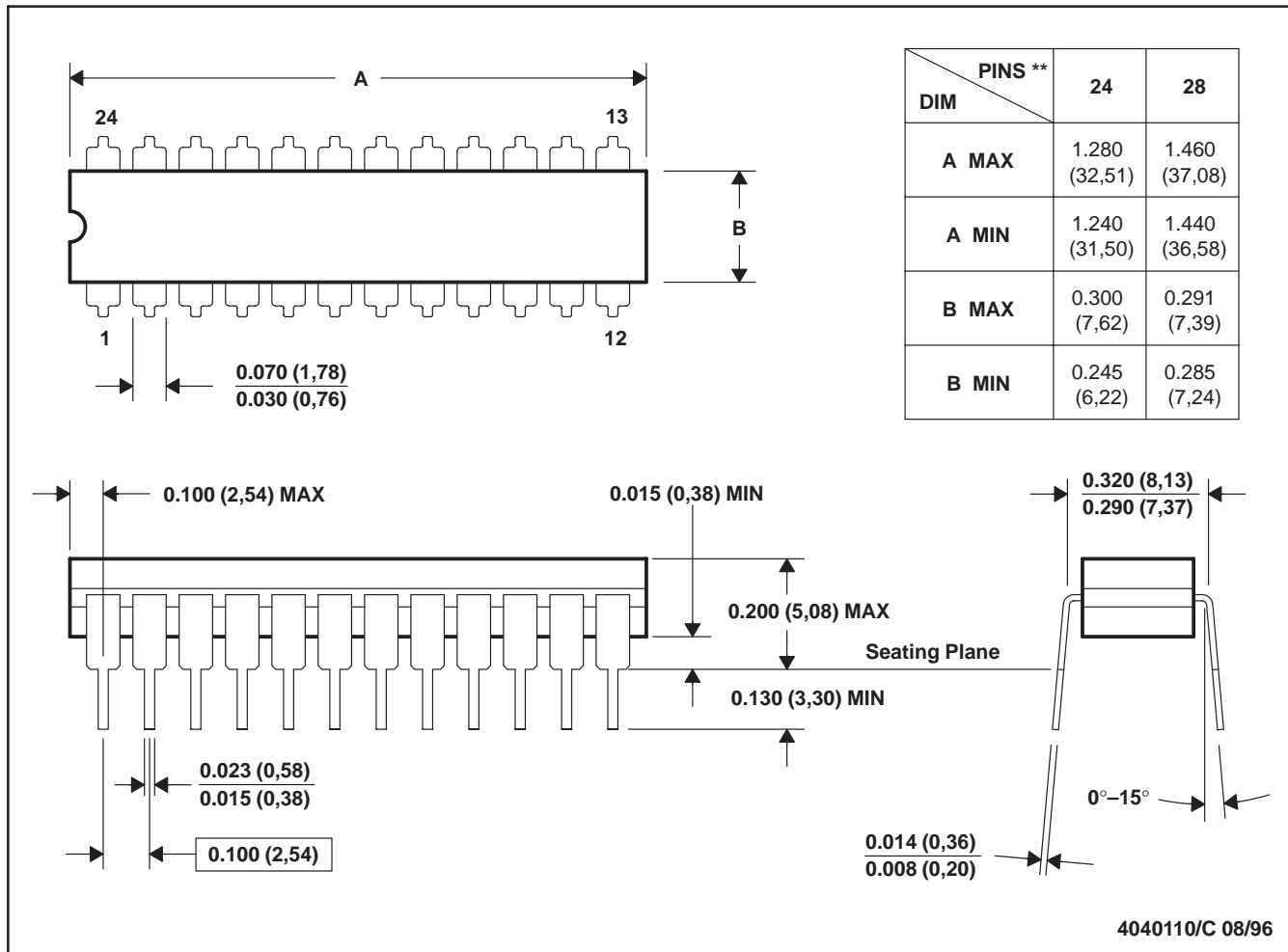
- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .  
 D. The outputs are measured one at a time, with one transition per measurement.  
 E. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

JT (R-GDIP-T\*\*)

CERAMIC DUAL-IN-LINE

24 LEADS SHOWN



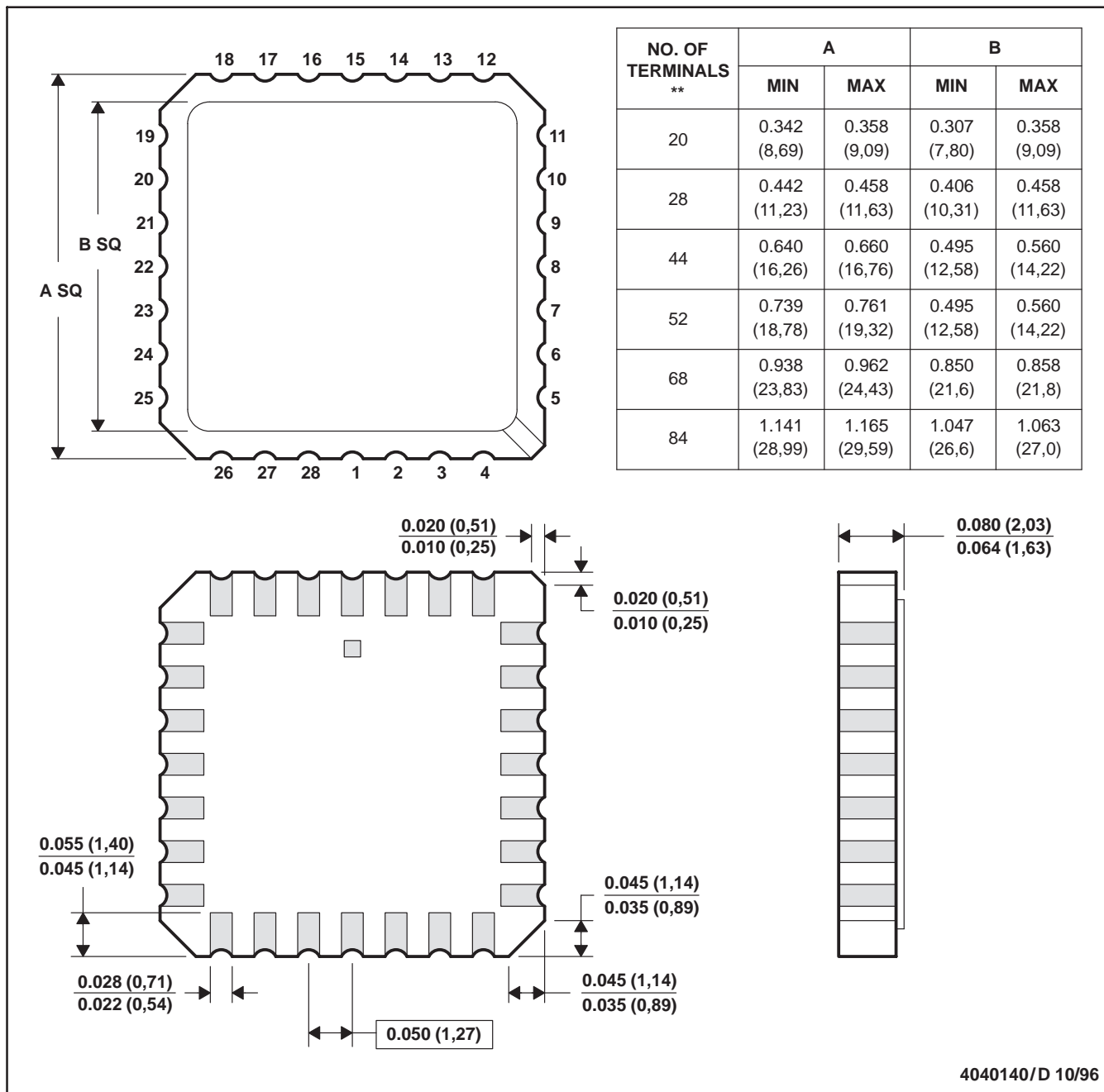
- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification.  
 E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB



FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004

DGV (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

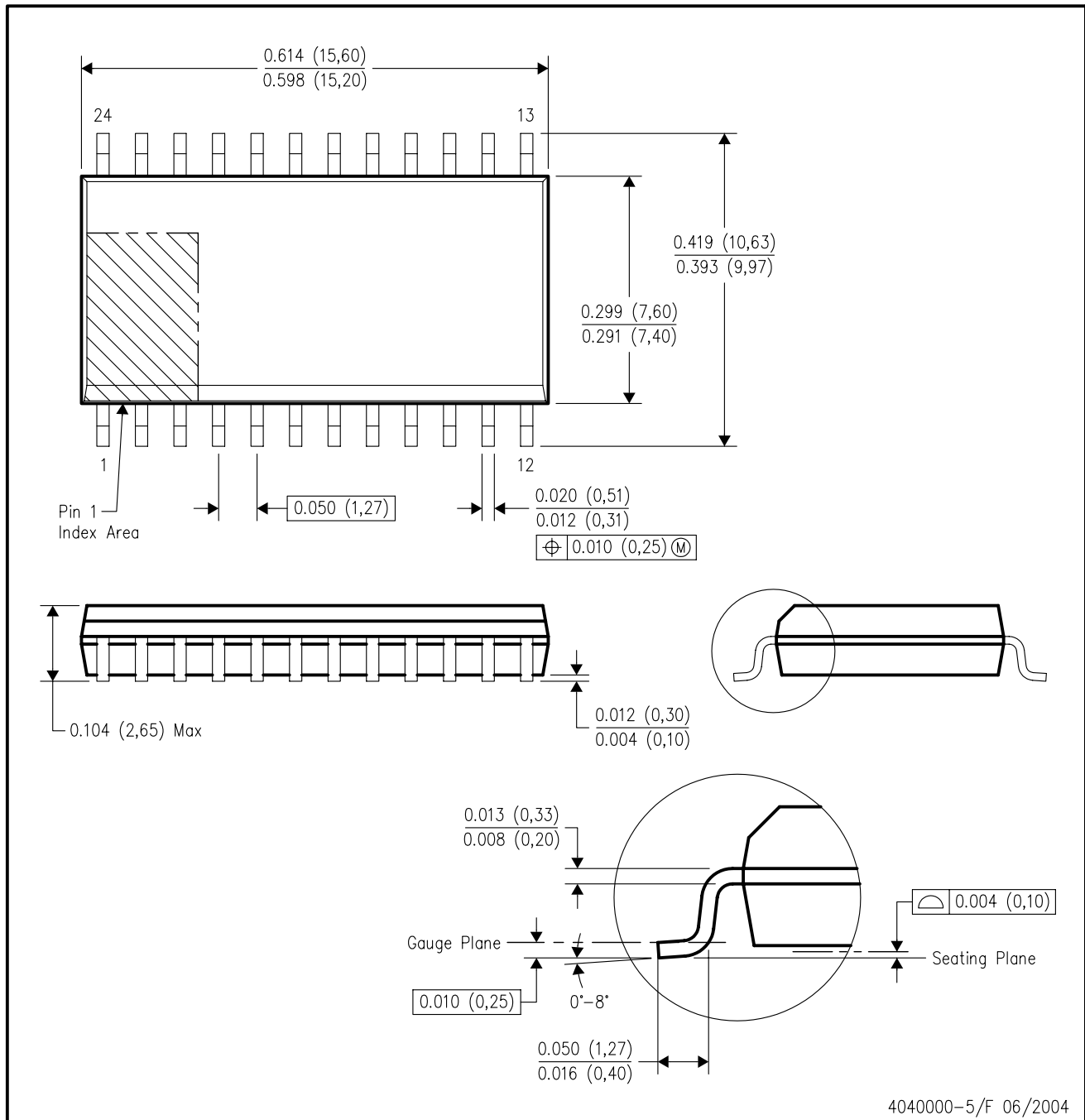
24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



4040000-5/F 06/2004

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AD.

## MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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